

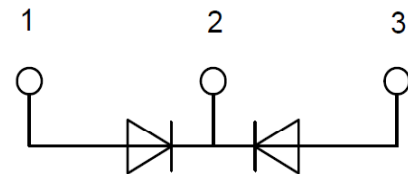
PRODUCT FEATURES

- Low V_F Trench FRED Technology
- Ultrafast Reverse Recovery Time
- Low Reverse Recovery Loss
- High Surge Current Capability



APPLICATIONS

- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- PFC



ABSOLUTE MAXIMUM RATINGS ($T_C = -25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_R	Maximum D.C. Reverse Voltage		100	V
V_{RRM}	Maximum Repetitive Reverse Voltage			
$I_{F(AV)}$	Average Forward Current	$T_C = 110^\circ\text{C}$, Per Diode	200	A
		$T_C = 110^\circ\text{C}$, Per Module	400	
$I_{F(RMS)}$	RMS Forward Current	$T_C = 110^\circ\text{C}$, Per Diode	282	
I_{FSM}	Non Repetitive Surge Forward Current	$T_J = 45^\circ\text{C}$, $t = 10\text{ms}$, Sine, peak value	2500	
		$T_J = 45^\circ\text{C}$, $t = 8.3\text{ms}$, Sine, peak value	2750	
I^2t	For Fusing	$T_J = 45^\circ\text{C}$, $t = 10\text{ms}$, Sine, peak value	31.25	KA ² S
		$T_J = 45^\circ\text{C}$, $t = 8.3\text{ms}$, Sine, peak value	31.38	
P_D	Power Dissipation		520	W
T_J	Junction Temperature		-40 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-40 to +125	$^\circ\text{C}$
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), $t = 1\text{minute}$	3000	V
Torque	Module to Sink	Recommended (M5)	2.5~4	Nm
Torque	Module Electrodes	Recommended (M5)	2.5~4	Nm
R_{thJC}	Junction to Case Thermal Resistance(Per Diode)		0.24	$^\circ\text{C}/\text{W}$
Weight			100	g

KEF400N010DK6B

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Min.	Typ.	Max.	Unit
I_{RM}	Maximum Reverse Leakage Current	$V_R = 100\text{V}$		1	mA
		$V_R = 100\text{V}, T_J = 125^\circ\text{C}$		100	
V_F	Forward Voltage	$I_F=200\text{A}$	0.62	0.7	V
		$I_F=200\text{A}, T_J=125^\circ\text{C}$	0.6		
t_{rr}	Reverse Recovery Time ($I_F = 1\text{A}, di_F/dt = -200\text{A}/\mu\text{s}, V_R = 30\text{V}$)		100		ns
t_{rr}	Reverse Recovery Time		105		ns
I_{RRM}	Maximum Reverse Recovery Current		9.5		A

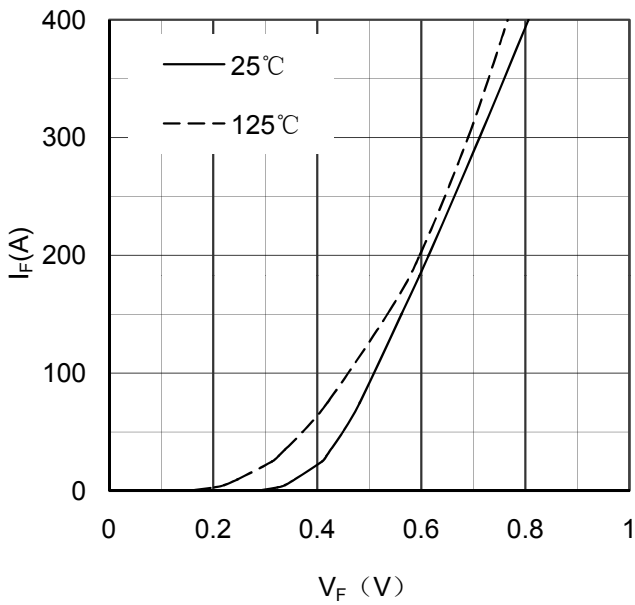


Figure 1. Forward Voltage Drop vs Forward Current

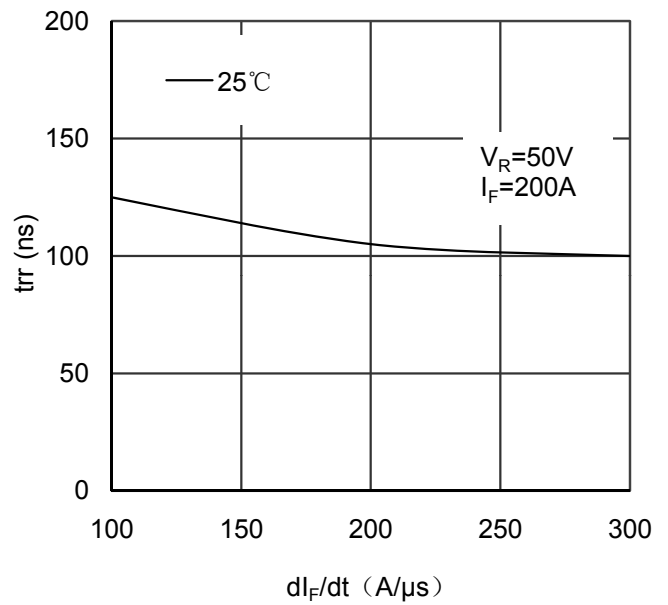


Figure 2. Reverse Recovery Time vs di_F/dt

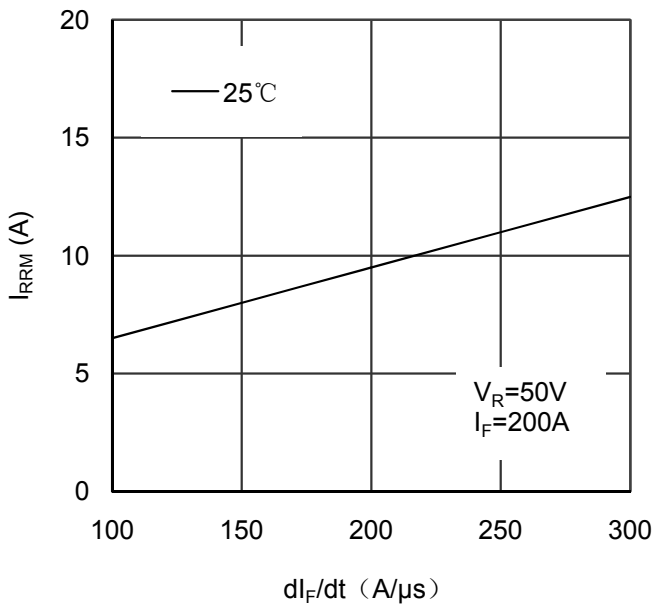


Figure 3. Reverse Recovery Current vs di_F/dt

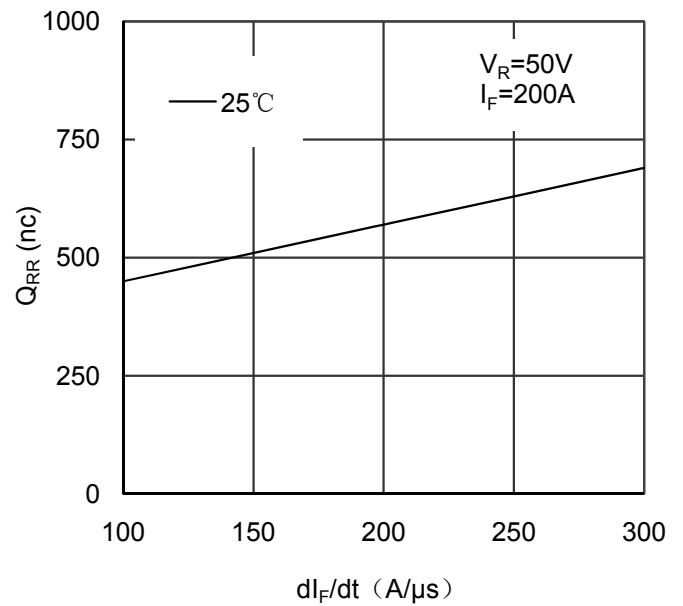


Figure 4. Reverse Recovery Charge vs di_F/dt

KEF400N010DK6B

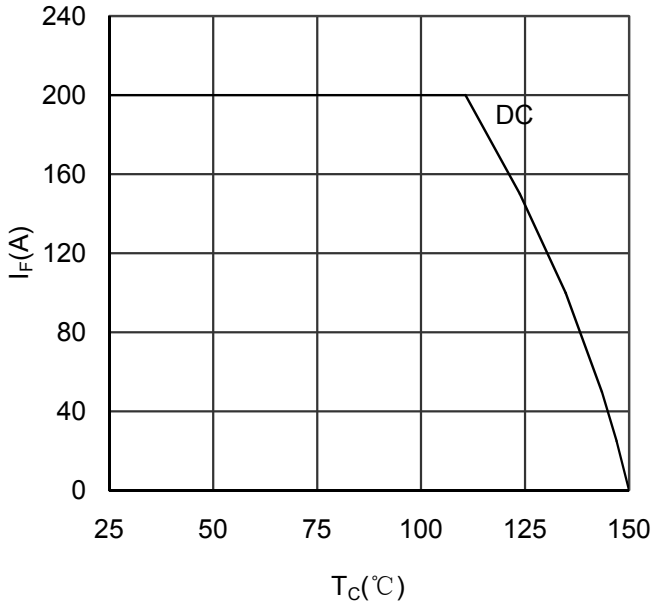


Figure 5. Forward current vs Case temperature

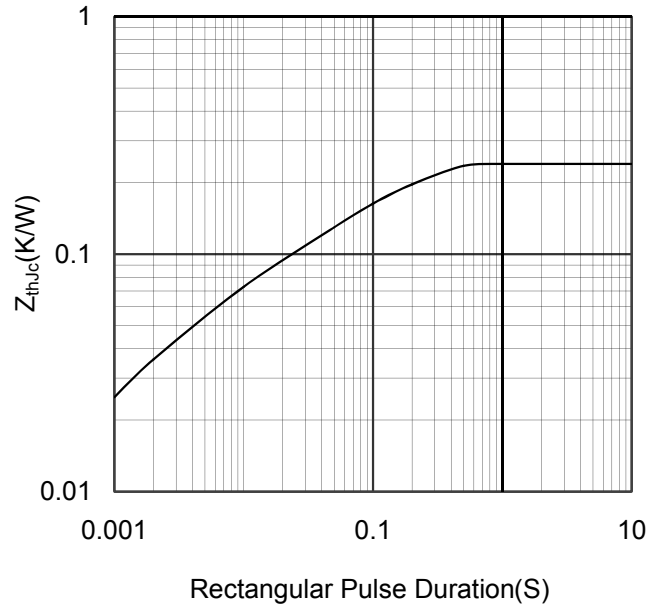
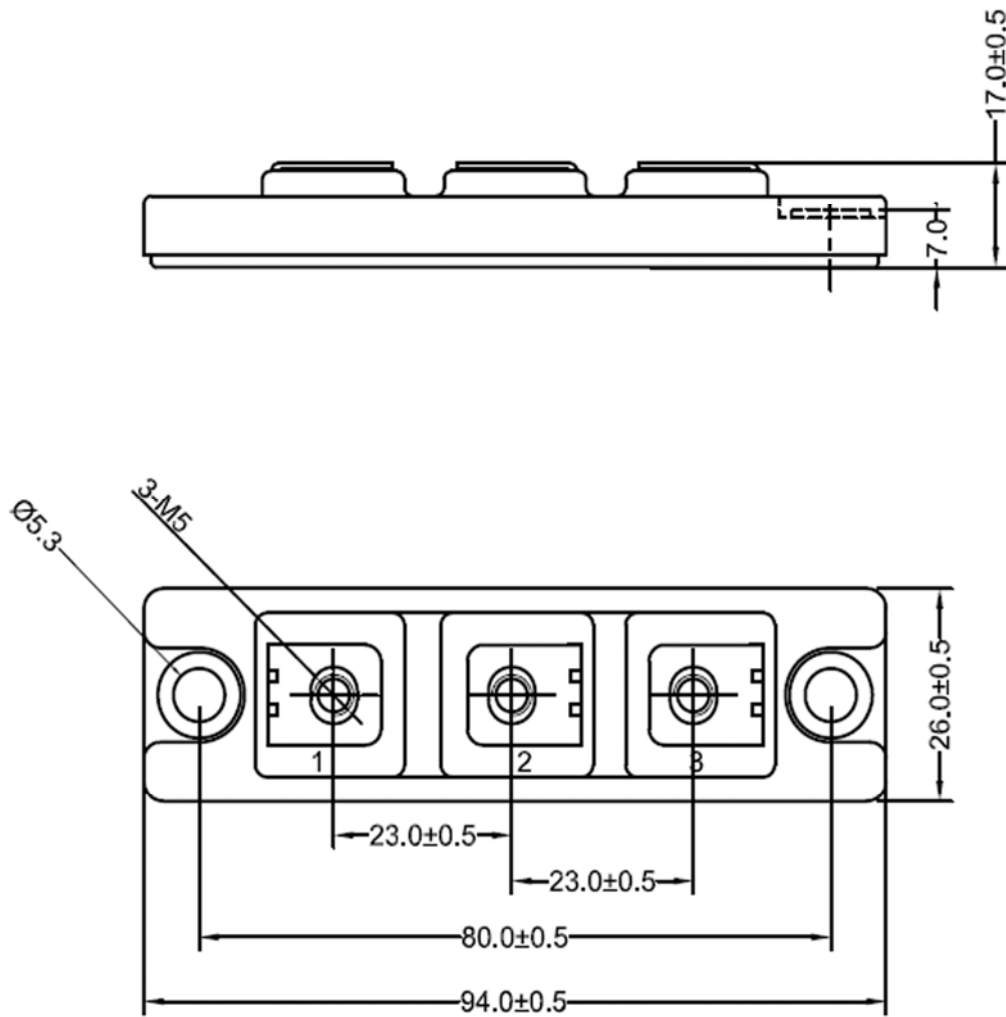


Figure 6. Transient Thermal Impedance



Dimensions in (mm)
Figure 7. Package Outline